

*A Survey and Taxonomy of Electronics Toolkits
for Interactive and
Ubiquitous Device Prototyping*

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INTRODUCTION

- General-purpose computing devices like personal computers, tablets and smartphones.
- Developing embedded solution based on custom microcontroller circuit.
- Hardware development systems such as Arduino and Phidgets.
- Processor speed, amount of memory and nature of supported input and output modalities are different.
- Several toolkits require skills in either programming or electronics.
- Sometimes the resulting prototype can run standalone.
- Some toolkits are generic in nature while others are particularly suited for building specific types of prototype.



Arduino



Custom MCU

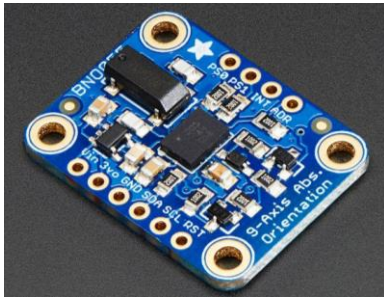
APPROACHES TO ELECTRONICS PROTOTYPING

- Type 1 -Prototyping with Discrete Components
 - It would be difficult to build a copy of a circuit
 - Requires significant knowledge of electronics
- Type 2a: Integrated Microcontroller Development Boards
 - any given design typically requires integration with components that are not present on the ready-made MCU
- Type 2b: Breakout Boards and Wireless Modules
 - Need to be combined them with Type 2a and/or Type 1
 - The Advantage of Type 2 electronics prototyping over Type 1 is speed and robustness
- Type 3: Integrated Modular Systems
 - Adding discrete components or building custom modules is often hard.
 - It simplifies and expedite electronics prototyping

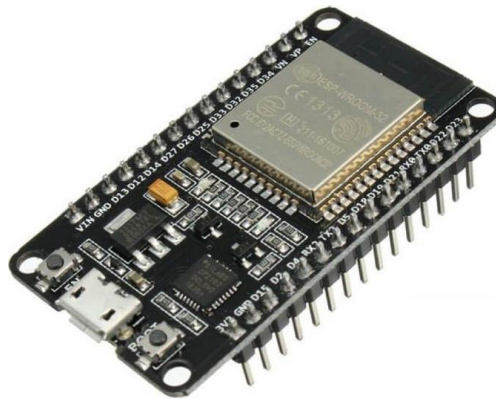


Toolkits

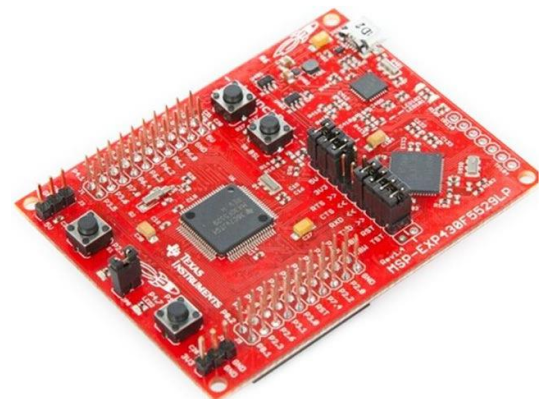
- Generic breakout boards
- Programmable low-cost WiFi modules
- Silicon vendor development boards
- FPGA development boards



Bosch BNO055
IMU sensor



ESP32



TI Lanchpad

ELECTRONIC PROTOTYPING PLATFORM TAXONOMY

- Nature and Application

| | Specific toolkits | | | Generic Breakout boards | Low-cost WiFi modules | Silicon vendor MCU dev. boards | | FPGA dev. boards |
|--|------------------------------|--------------------------|----------------------------|-------------------------|-----------------------|--------------------------------|--------|----------------------|
| Type of electronics | Type 2a (35%) | Type 2b (10%) | Type 3 (65%) | Type 2b | Type 2a | Type 2a | Type 3 | Type 2a |
| Electronic sub-domain | Wearables/textiles (15%) | Home automation (3%) | Interactive paper (3%) | | | | | |
| | Robotic vehicles/drones (3%) | Musical instruments (2%) | Biomedical sensing (2%) | n/a | n/a | n/a | | n/a |
| | AI/ML (2%) | n/a (70%) | | | | | | |
| Promoted with user groups (multi-value) | K-12 Education (50%) | Makers (77%) | Electronic engineers (35%) | Makers | Makers | Makers | | Makers |
| | | | | Electronic engineers | Electronic engineers | Electronic engineers | | Electronic engineers |

- Assembly of Prototypes

| | Specific toolkits | | | Generic Breakout boards | Low-cost WiFi modules | Silicon vendor MCU dev. boards | FPGA dev. boards |
|---|-----------------------------|-------------------------|-------------------------------|-------------------------|-----------------------|--------------------------------|-----------------------|
| Type of connection | Individual conductors (45%) | Multi-wire cables (27%) | Direct module-to-module (38%) | Individual conductors | Individual conductors | Individual conductors | Individual conductors |
| | Wireless (5%) | | | | | | |
| Connection mechanism (multi value) | Friction fit (67%) | Magnetic (8%) | Locking (7%) | | | | |
| | Crocodile clips (8%) | Adhesive(3%) | Thread (3%) | Friction fit | Friction fit | Friction fit | Friction fit |
| | Screws (2%) | Wireless (5%) | | | | | |
| Connection topology | Star (45%) | Hybrid (25%) | Bus (30%) | Star | Star | Star | Star |

ELECTRONIC PROTOTYPING PLATFORM TAXONOMY (1)

- Deploying and Configuring

| | Specific toolkits | | | Generic Breakout boards | Low-cost WiFi modules | Silicon vendor MCU dev. boards | FPGA dev. boards |
|---|------------------------------|------------------------------|----------------------------|-------------------------|------------------------|--------------------------------|------------------------|
| Programming style | Physical configuration (20%) | Software configuration (75%) | n/a (10%) | n/a | Software configuration | Software configuration | Software configuration |
| Dependencies for programming (multi-value) | Fully self-contained (23%) | Connected wirelessly (12%) | Tethered to computer (73%) | n/a | Tethered to computer | Tethered to computer | Tethered to computer |
| | n/a (8%) | | | | | | |
| Dependencies during deployment | Fully self-contained (80%) | Connected wirelessly(3%) | Tethered to computer(8%) | n/a | Fully self-contained | Fully self-contained | Fully self-contained |
| | n/a (8%) | | | | | | |

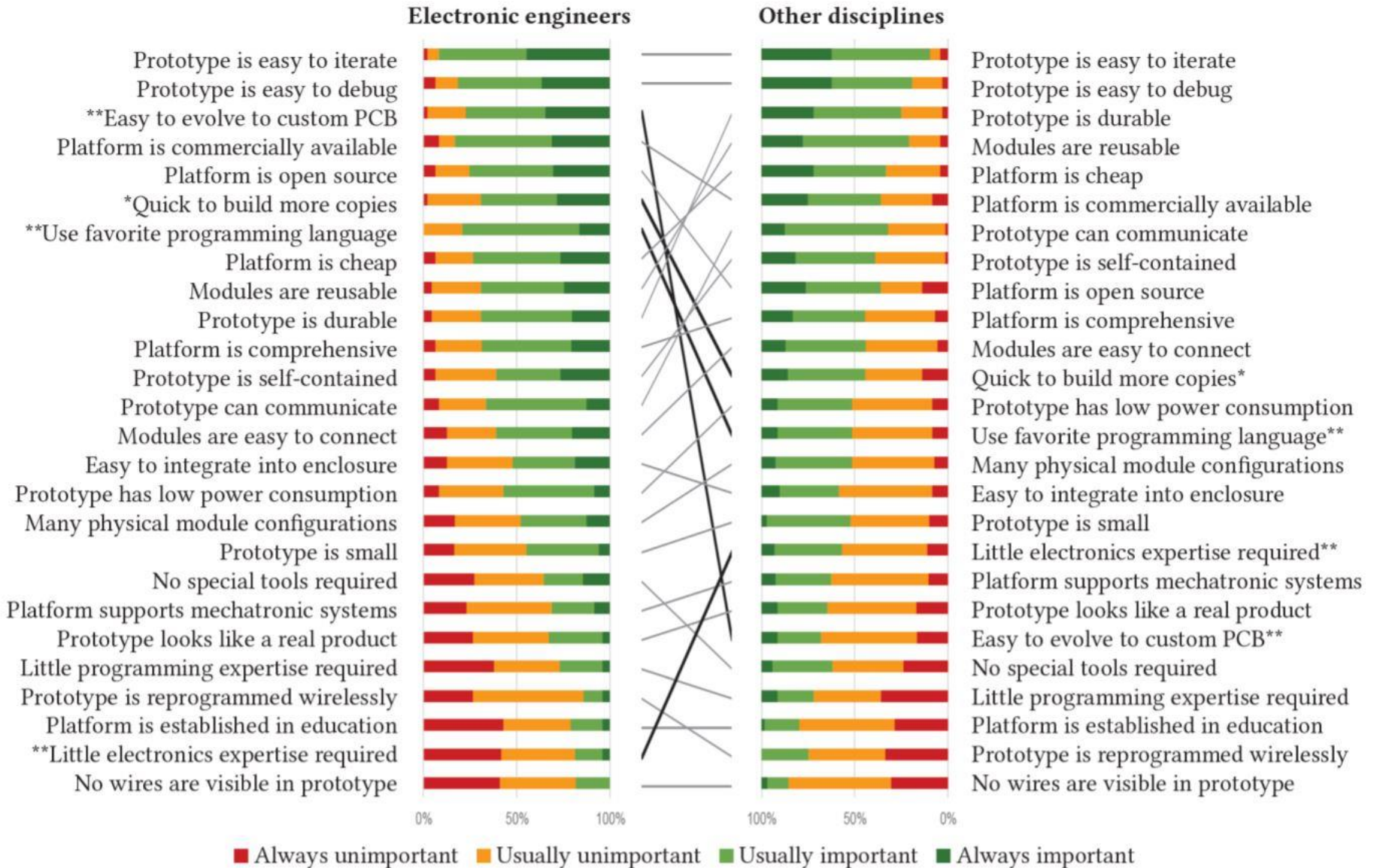
- Availability and Adoption

| | Specific toolkits | | | Generic Breakout boards | Low-cost WiFi modules | Silicon vendor MCU dev. boards | FPGA dev. boards |
|-------------------------------|-----------------------------|----------------------|-----------------------------|-------------------------|------------------------|--------------------------------|-----------------------|
| Existing use | In commercial products (7%) | Multiple copies (7%) | Only used in one-offs (86%) | Multiple copies | In commercial products | Only used in one-offs | Only used in one-offs |
| Commercially available | Yes (67%) | No longer (2%) | Never (31%) | Yes | Yes | Yes | Yes |
| Third party use | Yes (86%) | No (17%) | | Yes | Yes | Yes | Yes |
| Open source | Fully (45%) | Partial (42%) | Closed (13%) | Fully | Fully | Fully | Fully |

ANALYZING THE CHARACTERISTICS

- The level of electronics expertise required.
 - Type of connection
 - Connection topology
- The level of programming expertise required.
 - Programming style
- The ease of construction of a prototype.
- Ease of moving from a prototype to a product.
 - Existing use
 - Dependency during deployment
 - Open source

SURVEY ON ELECTRONICS TOOLKITS



SURVEY ON ELECTRONICS TOOLKITS (1)

- Only 10% of our respondents often started the prototyping process with a Type 3 toolkit.
- 39% of respondents reported they often make copies using a custom PCB.
- 12% of respondents often make copies using the same prototyping platform as used for the one-off prototype.
- 53% of all respondents often start the process with Type 2a development boards, 44% often start with solderless breadboard.